PMEG4010EH; PMEG4010EJ; PMEG4010ET

1 A very low V_F MEGA Schottky barrier rectifiers

Rev. 04 — 21 March 2007

Product data sheet

1. Product profile

1.1 General description

Planar Maximum Efficiency General Application (MEGA) Schottky barrier rectifiers with an integrated guard ring for stress protection, encapsulated in small Surface-Mounted Device (SMD) plastic packages.

Table 1. Product overview

Type number	Package			Configuration
	Nexperia	JEITA	JEDEC	
PMEG4010EH	SOD123F	-	-	single
PMEG4010EJ	SOD323F	SC-90	-	single
PMEG4010ET	SOT23	-	TO-236AB	single

1.2 Features

Forward current: I_F ≤ 1 A

Reverse voltage: V_R ≤ 40 V

Very low forward voltage

Small SMD plastic packages

1.3 Applications

- Low voltage rectification
- High efficiency DC-to-DC conversion
- Switch mode power supply
- Reverse polarity protection
- Low power consumption applications

1.4 Quick reference data

Table 2. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _F	forward current	$T_{sp} \le 55 ^{\circ}C$	-	-	1	Α
V_R	reverse voltage		-	-	40	V
V _F	forward voltage	$I_F = 1000 \text{ mA}$	<u>[1]</u> _	540	640	mV

^[1] Pulse test: $t_p \le 300~\mu s;~\delta \le 0.02.$



2. Pinning information

Table 3. Pinning

Table 3.	Filling	
Pin	Description	Simplified outline Symbol
SOD123F	; SOD323F	
1	cathode	[1]
2	anode	1 1 2 sym001
SOT23		
1	anode	
2	n.c.	3
3	cathode	1 2 1 2 006aaa436

^[1] The marking bar indicates the cathode.

3. Ordering information

Table 4. Ordering information

Type number	Package					
	Name	Description	Version			
PMEG4010EH	-	plastic surface-mounted package; 2 leads	SOD123F			
PMEG4010EJ	SC-90	plastic surface-mounted package; 2 leads	SOD323F			
PMEG4010ET	-	plastic surface-mounted package; 3 leads	SOT23			

4. Marking

Table 5. Marking codes

Type number	Marking code ^[1]
PMEG4010EH	AB
PMEG4010EJ	AL
PMEG4010ET	*AW

[1] * = -: made in Hong Kong

* = p: made in Hong Kong

* = t: made in Malaysia

* = W: made in China

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Limiting values

Table 6. **Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	N	1in	Max	Unit
V_{R}	reverse voltage		-		40	V
I _F	forward current	T _{sp} ≤ 55 °C	-		1	Α
I _{FRM}	repetitive peak forward current	$t_p \le 1$ ms; $\delta \le 0.25$				
	PMEG4010EH		-		7	Α
	PMEG4010EJ		-		7	Α
	PMEG4010ET		-		5	Α
I _{FSM}	non-repetitive peak forward current	square wave; t _p = 8 ms	-		9	Α
P _{tot}	total power dissipation	$T_{amb} \le 25 ^{\circ}C$				
	PMEG4010EH		[1][3]		375	mW
			[2][3]		830	mW
	PMEG4010EJ		[1][3]		350	mW
			[2][3]		830	mW
	PMEG4010ET		<u>[1]</u> _		280	mW
			[2] _		420	mW
Tj	junction temperature		-		150	°C
T _{amb}	ambient temperature		_	65	+150	°C
T _{stg}	storage temperature		_	65	+150	°C

^[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard

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Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

Reflow soldering is the only recommended soldering method.

6. Thermal characteristics

Table 7. Thermal characteristics

Parameter	Conditions		Min	Тур	Max	Unit
thermal resistance from unction to ambient	in free air	<u>[1]</u>				
PMEG4010EH		[2][4]	-	-	330	K/W
		[3][4]	•	-	150	K/W
PMEG4010EJ		[2][4]	•	-	350	K/W
		[3][4]	•	-	150	K/W
PMEG4010ET		[2]	•	-	440	K/W
		[3]	•	-	300	K/W
thermal resistance from unction to solder point		<u>[5]</u>				
PMEG4010EH			-	-	60	K/W
PMEG4010EJ			-	-	55	K/W
PMEG4010ET			-	-	120	K/W
	thermal resistance from unction to ambient PMEG4010EH PMEG4010EJ PMEG4010ET Thermal resistance from unction to solder point PMEG4010EH PMEG4010EH PMEG4010EJ	thermal resistance from in free air unction to ambient PMEG4010EH PMEG4010EJ PMEG4010ET thermal resistance from unction to solder point PMEG4010EH PMEG4010EH PMEG4010EJ	thermal resistance from in free air unction to ambient PMEG4010EH [2][4] PMEG4010EJ [2][4] PMEG4010ET [2] [3] thermal resistance from unction to solder point PMEG4010EH PMEG4010EJ	thermal resistance from in free air unction to ambient PMEG4010EH PMEG4010EJ PMEG4010EJ PMEG4010ET Ethermal resistance from unction to solder point PMEG4010EH PMEG4010EH PMEG4010EJ - In the property of the propert	thermal resistance from in free air unction to ambient PMEG4010EH PMEG4010EJ PMEG4010EJ PMEG4010ET PMEG4010ET 121 131 141 15	thermal resistance from in free air unction to ambient PMEG4010EH PMEG4010EJ [2][4] 330 [3][4] 150 PMEG4010EJ [2][4] 350 [3][4] 150 PMEG4010ET [2] 440 [3] 300 Thermal resistance from unction to solder point PMEG4010EH PMEG4010EJ 60 PMEG4010EJ 55

^[1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P_R are a significant part of the total power losses.

7. Characteristics

Table 8. Characteristics

T_{amb} = 25 °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{F}	forward voltage		<u>[1]</u>			
		$I_F = 0.1 \text{ mA}$	-	95	130	mV
		I _F = 1 mA	-	155	210	mV
		$I_F = 10 \text{ mA}$	-	220	270	mV
		$I_F = 100 \text{ mA}$	-	295	350	mV
		$I_F = 500 \text{ mA}$	-	420	470	mV
		$I_F = 1000 \text{ mA}$	-	540	640	mV
I_R	reverse current	$V_R = 10 V$	-	7	20	μΑ
		V _R = 40 V	-	30	100	μΑ
C _d	diode capacitance	$V_R = 1 V;$ f = 1 MHz	-	43	50	pF

^[1] Pulse test: $t_p \le 300~\mu s;~\delta \le 0.02.$

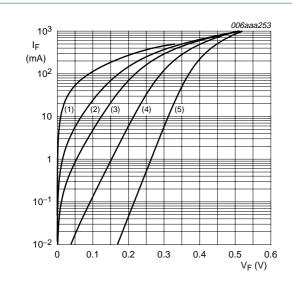
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^[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

^[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

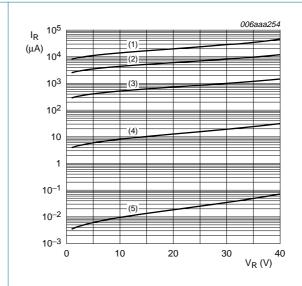
^[4] Reflow soldering is the only recommended soldering method.

^[5] Soldering point of cathode tab.



- (1) $T_{amb} = 150 \, ^{\circ}C$
- (2) $T_{amb} = 125 \, ^{\circ}C$
- (3) $T_{amb} = 85 \, ^{\circ}C$
- (4) $T_{amb} = 25 \,^{\circ}C$
- (5) $T_{amb} = -40 \, ^{\circ}C$

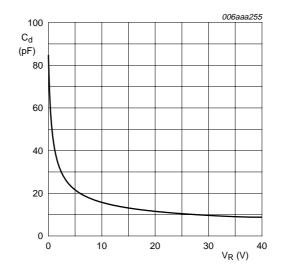
Fig 1. Forward current as a function of forward voltage; typical values



- (1) $T_{amb} = 150 \, ^{\circ}C$
- (2) $T_{amb} = 125 \, ^{\circ}C$
- (3) $T_{amb} = 85 \, ^{\circ}C$
- (4) $T_{amb} = 25 \,^{\circ}C$
- (5) $T_{amb} = -40 \, ^{\circ}C$

Fig 2. Reverse current as a function of reverse voltage; typical values

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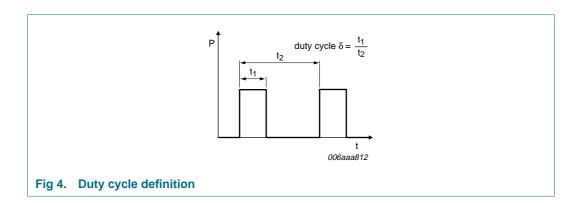
 $f = 1 \text{ MHz}; T_{amb} = 25 ^{\circ}\text{C}$

Fig 3. Diode capacitance as a function of reverse voltage; typical values

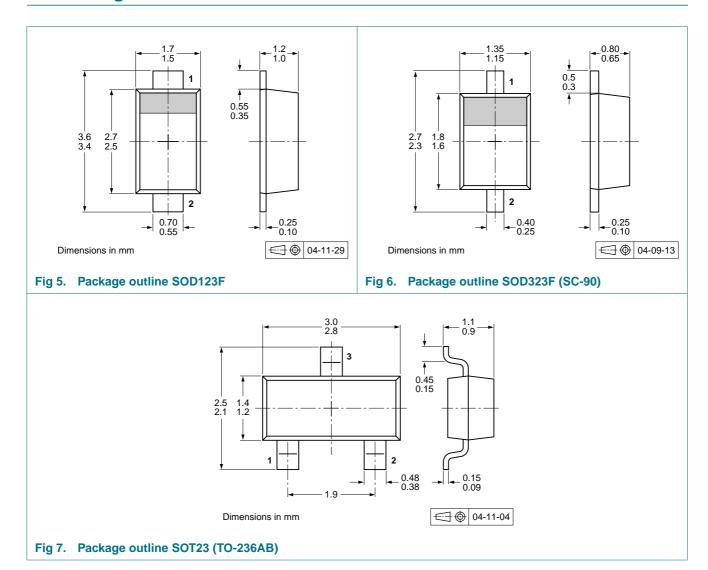
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8. Test information



9. Package outline



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10. Packing information

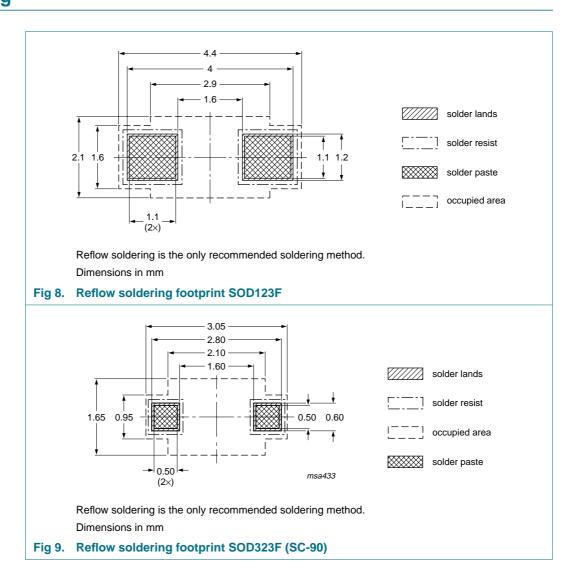
Table 9. **Packing methods**

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	Package	Description	Packing	quantity
			3000	10000
PMEG4010EH	SOD123F	4 mm pitch, 8 mm tape and reel	-115	-135
PMEG4010EJ	SOD323F	4 mm pitch, 8 mm tape and reel	-115	-135
PMEG4010ET	SOT23	4 mm pitch, 8 mm tape and reel	-215	-235

^[1] For further information and the availability of packing methods, see Section 14.

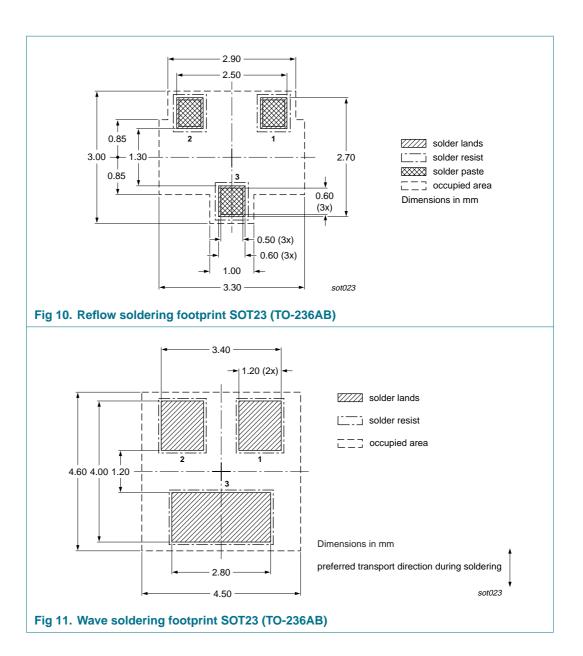
11. Soldering



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12. Revision history

Table 10. Revision history

•						
Document ID	Release date	Data sheet status	Change notice	Supersedes		
PMEG4010EH_EJ_ET_4	20070321	Product data sheet	-	PMEGXX10EH_EJ_SER_3		
Modifications:		of this data sheet has be of NXP Semiconductors	en redesigned to com	ply with the new identity		
	 Legal texts have been adapted to the new company name where appropriate. 					
 Type numbers PMEG4010EH and PMEG4010EJ separated from data sheet PMEGXX10EH_EJ_SER_3 						
	 Type number 	er PMEG4010ET added				
	 Section 1.1 	"General description": ar	mended			
	Section 1.2	"Features": amended				
	 Section 1.3 	"Applications": amended	I			
	Section 8 "1	Test information": added				
	• Figure 7, 10	and <u>11</u> : added				
	 Section 13 	"Legal information": upda	ited			
PMEGXX10EH_EJ_SER_3	20050411	Product data sheet	-	PMEGXX10EJ_SER_2		
PMEGXX10EJ_SER_2	20050131	Product data sheet	-	PMEGXX10EJ_SER_1		
PMEGXX10EJ_SER_1	20040907	Objective data sheet	-	-		

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13. Legal information

13.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nexperia.com.

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